半导体数据手册(止册)

Semiconductors: Data Handbook

3rd Edition

Otfried Madelung



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3rd Edition

Otfried Madelung

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by Otfried Madelung

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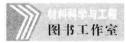
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Semiconductors: Data Handbook

3rd edition



Preface

"The frequent use of well known critical data handbooks like Beilstein, Gmelin and Landolt -Börnstein is impeded by the fact that only larger libraries - often far away from the scientist's working place - can afford such precious collections. To satisfy an urgent need of many scientists working in the field of semiconductor physics for having at their working place a comprehensive, high quality, but inexpensive collection of at least the basic data of their field of interest this volume contains the most important data of semiconductors. All data were compiled from information on semiconductors presented on more than 6 000 pages in various volumes of the New Series of Landolt - Börnstein."

With these words the aim of the volume "Semiconductors – Basic Data", published by the present author – was defined in the preface to its first Edition. This edition – published in two volumes in the Series "Data in Science and Technology" – appeared in 1991/92. The 2nd Edition was published in one volume five years later.

While preparing the third edition, it became clear that a complete revision was necessary for several reasons:

- To the eleven subvolumes of volumes III/17 and III/22 of the New Series of Landolt-Börnstein published between 1982 and 1988 eight new supplementary subvolumes (III/41) appeared in the meantime. The 19 volumes now available comprise about 10 000 pages with more than 13 000 figures. Thus, much new data had to be included in this collection of basic data.
- The Landolt -Börnstein series is now available on the Internet. So easy access to the data via Internet had to be considered in the structure of this volume.
- Last but not least the possibility to combine a printed medium with an enclosed CD-ROM gives the opportunity to improve the value of a data collection by shifting parts of the information onto the CD-ROM, thereby increasing the amount of information substantially without an undue increase of the number of pages.

By this opportunity, a drawback of earlier editions could be eliminated: To limit the number of pages, a comprehensive presentation of the most important data was only possible for the group IV and III-V semiconductors. All other groups of semiconductors could only be handled very briefly in tabular form with a restricted number of figures and without references. This drawback is now eliminated. The (printed) volume contains the basic data for all known groups of semiconductors in suitable lenght. Figures on crystal structures and band structures supplement the tables.

Further information was shifted to the CD-ROM:

- Figures. A user of this book usually first looks for data collected in tables. Figures can supply deeper information by presenting functional dependences, such as temperature dependence, pressure dependence, and by presenting dispersion curves, optical spectra etc. Such additional information is now provided in about 1000 additional figures on the CD-ROM. Presenting these figures in the printed version had required several hundred pages.
- References. The knowledge of the origin of data is necessary for the user to find the context in which the data were measured. Thus, data presented in this volume should also contain more than 100 pages of references. These references were shifted to the enclosed CD-ROM.
- Additional information useful for the reader but too spacious to be presented in the printed version. There are a large number of substances (e.g. boron compounds, transition metal and rare earths compounds) exhibiting "semi-conducting properties". A presentation of data referring to such substances in the printed text seemed to be too extensive and was therefore left to the CD-ROM

Thus, the present edition differs substancially from the former editions in the amount of information and the manner of presentation (and unavoidable also in the number of pages). To emphasize this change the title of the third edition has been changed from "Semiconductors: Basic Data" to "Semiconductors: Data Handbook".

I do hope the users of the volume will profit from these innovations.

Marburg, August 2003

Otfried Madelung

Detailed table of contents

A	Introduction	2.18	Quaternary alloys lattice matched to	
1	General remarks to the structure of this		binary III-V compounds	7
	volume1			
2	Physical quantities tabulated in this volume 2	3	II-VI compounds	
		3.0	Crystal structure and electronic structure 17	3
В	Tetrahedrally bonded elements and	3.1	Beryllium oxide (BeO)18	0
	compounds	3.2	Beryllium sulfide (BeS) 18	2
		3.3	Beryllium selenide (BeSe) 18	2
1	Elements of the IVth group and IV-IV	3.4	Beryllium telluride (BeTe)18	3
	compounds	3.5	Magnesium oxide (MgO)18	4
1.0	Crystal structure and electronic structure7	3.6	Magnesium sulfide (MgS) 18	6
1.1	Diamond (C)11	3.7	Magnesium selenide (MgSe) 18	6
1.2	Silicon (Si)16	3.8	Magnesium telluride (MgTe) 18	37
1.3	Germanium (Ge)45	3.9	Calcium oxide (CaO) 18	7
1.4	Grey tin (α-Sn)57	3.10	Strontium oxide (SrO)	0
1.5	Silicon carbide (SiC)60	3.11	Barium oxide (BaO)	2
1.6	Silicon germanium mixed crystals	3.12	Zinc oxide (ZnO) 19	14
	(Si_XGe_{1-X}) 70	3.13	Zinc sulfide (ZnS)	00
		3.14	Zinc selenide (ZnSe)	8
2	III-V compounds	3.15	Zinc telluride (ZnTe)21	3
2.0	Crystal structure and electronic structure71	3.16	Cadmium oxide (CdO)21	8
2.1	Boron nitride (BN)79	3.17	Cadmium sulfide (CdS)	20
2.2	Boron phosphide (BP)84	3.18	Cadmium selenide (CdSe)22	26
2.3	Boron arsenide (BAs)87	3.19	Cadmium telluride (CdTe)	32
2.4	Boron antimonide (BSb)88	3.20	Mercury oxide (HgO)23	35
2.5	Aluminum nitride (AlN)88	3.21	Mercury sulfide (HgS)	36
2.6	Aluminum phosphide (AlP)91	3.22	Mercury selenide (HgSe) 23	39
2.7	Aluminum arsenide (AlAs)94	3.23	Mercury telluride (HgTe)24	11
2.8	Aluminum antimonide (AlSb)98			
2.9	Gallium nitride (GaN)103	4	I-VII compounds	
2.10	Gallium phosphide (GaP)109	4.0	Crystal structure and electronic structure 24	15
2.11	Gallium arsenide (GaAs)117	4.1	Cuprous fluoride (CuF)24	18
2.12	Gallium antimonide (GaSb)129	4.2	Cuprous chloride (γ-CuCl)24	18
2.13	Indium nitride (InN)137	4.3	Cuprous bromide (γ-CuBr)25	54
2.14	Indium phosphide (InP)139	4.4	Cuprous iodide (γ-CuI)	59
2.15	Indium arsenide (InAs)148	4.5	Silver fluoride (AgF)	52
2.16	Indium antimonide (InSb)154	4.6	Silver chloride (AgCl)	
2.17	Ternary alloys lattice matched to binary	4.7	Silver bromide (AgBr)	
	III-V compounds162	4.8	Silver iodide (AgI)	71

5	III ₂ -VI ₃ compounds	7.3	Zinc silicon arsenide(ZnSiAs ₂)
5.0	Crystal structure of quasi-binary II ₂ -VI ₃	7.4	Zinc germanium nitride (ZnGeN ₂)
	compounds275	7.5	Zinc germanium phosphide (ZnGeP ₂) 339
5.1	Gallium sulfide (Ga ₂ S ₃)276	7.6	Zinc germanium arsenide (ZnGeAs ₂) 342
5.2	Gallium selenide (Ga ₂ Se ₃)278	7.7	Zinc tin phosphide (ZnSnP ₂)343
5.3	Gallium telluride (Ga ₂ Te ₃)280	7.8	Zinc tin arsenide (ZnSnAs ₂)344
5.4	Indium sulfide (In ₂ S ₃)281	7.9	Zinc tin antimonide (ZnSnSb ₂)
5.5	Indium selenide (In ₂ Se ₃)283	7.10	Cadmium silicon phosphide (CdSiP ₂) 346
5.6	Indium telluride (In ₂ Te ₃)286	7.11	Cadmium silicon arsenide (CdSiAs ₂) 348
		7.12	Cadmium germanium phosphide
6	I-III-VI2 compounds		(CdGeP ₂)
	(included are I-Fe-VI ₂ compounds)	7.13	Cadmium germanium arsenide
6.0	Crystal structure and electronic structure 289		(CdGeAs ₂)
6.1	Copper aluminum sulfide (CuAlS ₂)292	7.14	Cadmium tin phosphide (CdSnP ₂)355
6.2	Copper aluminum selenide (CuAlSe ₂)294	7.15	Cadmium tin arsenide (CdSnAs ₂)
6.3	Copper aluminum telluride (CuAlTe ₂)297		
6.4	Copper gallium sulfide (CuGaS ₂)298	8	I2-IV-VI3 compounds
6.5	Copper gallium selenide (CuGaSe ₂)302	8.1	Copper germanium sulfide (Cu ₂ GeS ₃) 359
6.6	Copper gallium telluride (CuGaTe ₂)304	8.2	Copper germanium selenide
6.7	Copper indium sulfide (CuInS ₂)306		(Cu ₂ GeSe ₃)
6.8	Copper indium selenide (CuInSe ₂)309	8.3	Copper germanium telluride
6.9	Copper indium telluride (CuInTe ₂)311		(Cu ₂ GeTe ₃)
6.10	Silver gallium sulfide (AgGaS ₂)313	8.4	Copper tin sulfide (Cu ₂ SnS ₃)
6.11	Silver gallium selenide (AgGaSe ₂)315	8.5	Copper tin selenide (Cu ₂ SnSe ₃)
6.12	Silver gallium telluride (AgGaTe ₂)318	8.6	Copper tin telluride (Cu ₂ SnTe ₃) 364
6.13	Silver indium sulfide (AgInS ₂)319	8.7	Silver germanium selenide (Ag ₂ GeSe ₃) 365
6.14	Silver indium selenide (AgInSe ₂)320	8.8	Silver germanium telluride (Ag ₂ GeTe ₃) 365
6.15	Silver indium telluride (AgInTe ₂)322	8.9	Silver tin sulfide (Ag ₂ SnS ₃)
6.16	Copper thallium sulfide (CuTlS ₂)324	8.10	Silver tin selenide (Ag ₂ SnSe ₃)
6.17	Copper thallium selenide (CuTlSe ₂)324	8.11	Silver tin telluride (Ag ₂ SnTe ₃)366
6.18	Copper thallium telluride (CuTlTe ₂)325		
6.19	Silver thallium selenide (AgTlSe ₂)325	9	I ₃ -V-VI ₄ compounds
6.20	Silver thallium telluride (AgTlTe ₂)325	9.0	Crystal structure
6.21	Copper iron sulfide (CuFeS ₂)326	9.1	Copper thiophosphate (Cu ₃ PS ₄) 368
6.22	Copper iron selenide (CuFeSe ₂)327	9.2	Copper thioarsenide, enargite, luzonite
6.23	Copper iron telluride (CuFeTe ₂)327		(Cu ₃ AsS ₄)
6.24	Silver iron selenide (AgFeSe ₂)328	9.3	Copper arsenic selenide (Cu ₃ AsSe ₄) 370
6.25	Silver iron telluride (AgFeTe ₂)328	9.4	Copper antimony sulfide, famatinite
			(Cu ₃ SbS ₄) 371
7	II-IV-V ₂ compounds	9.5	Copper antimony selenide (Cu ₃ SbSe ₄) 371
7.0	Crystal structure and electronic structure 329	9.6	Copper arsenic telluride (Cu ₃ AsTe ₄) 372
7.1	Magnesium silicon phosphide (MgSiP ₂)333	9.7	Copper antimony telluride (Cu ₃ SbTe ₄) 372
7.2	Zinc silicon phosphide (ZnSiP ₂)333		

10	II-III ₂ -VI ₄ compounds	10.10	Cadmium gallium telluride (CdGa ₂ Te ₄)386
10.0	Crystal structure and electronic structure 373	10.11	Cadmium thioindate (CdIn ₂ S ₄)387
10.1	Zinc aluminum sulfide (ZnAl ₂ S ₄)375	10.12	Cadmium indium selenide (CdIn ₂ Se ₄) 389
10.2	Zinc gallium sulfide (ZnGa ₂ S ₄)375	10.13	Cadmium indium telluride (CdIn ₂ Te ₄)39
10.3	Zinc gallium selenide (ZnGa ₂ Se ₄)377	10.14	Cadmium thallium selenide (CdTl ₂ Se ₄) 392
10.4	Zinc thioindate (ZnIn ₂ S ₄)378	10.15	Mercury thiogallate (HgGa ₂ S ₄)393
10.5	Zinc indium selenide (ZnIn ₂ Se ₄)379	10.16	Mercury gallium selenide (HgGa ₂ Se ₄)393
10.6	Zinc indium telluride (ZnIn ₂ Te ₄)381	10.17	Mercury indium telluride (HgIn ₂ Te ₄)394
10.7	Cadmium thioaluminate (CdAl ₂ S ₄)381	10.18	HgIn ₂ Se ₄ , Hg ₃ In ₂ Te ₆ , Hg ₅ In ₂ Te ₈ 39
10.8	Cadmium thiogallate (CdGa ₂ S ₄)382	10.19	Further II-III ₂ -VI ₄ compounds with
10.9	Cadmium gallium selenide (CdGa ₂ Se ₄)384		II = Mg, Ca

1

A Introduction

1 General remarks to the structure of this volume

This volume contains basic data of semiconductors. All data were compiled from the 17 volumes of the New Series of the Landolt-Börnstein data handbook, dealing with semiconductors. They comprise the information a scientist working an semiconductors is needing in his every-day work.

The volume consists of seven parts (A...G).

Part A contains introductory remarks.

In part B information about the properties of the important groups of tetrahedrally bonded semiconducting elements and compounds are given. The chapters 1 ... 10 cover the elements of the IVth group of the Periodic System and their isoelectronic analogues: the binary III-V, II-VI, I-VII compounds and the respective ternary compounds (vac-III₂-VI₃, I-III-VI₂, II-IV-V₂, I₂-V-VI₃, I₃-V-VI₄, II-III₂-VI₄ compounds).

The parts C, D and E cover further groups of semiconducting elements, binary and ternary compounds, respectively.

Part F summarizes informations about more than 100 substances which are described in the literature as having "semiconducting properties". Since these substances are of minor importance in semiconductor physics, the data of this chapter are only presented on the enclosed CD-ROM.

To facilitate the use of this book a Substance Index is presented in the part G, separately for the substances in chapters B ... E and for the substances in part F presented only on the CD-ROM.

The data presented in parts B ... E are ordered in chapters on specific substance groups. Most of these chapters begin with a "0"-section, presenting information about the crystal structure and the electronic structure of the semiconductors belonging to the respective substance group. Only these "0"-sections contain figures on lattice structures and on band structure.

Sections on the properties of individual substances follow. The data are ordered under the following headings:

- Crystal structure

lattice structure / space group / modifications / high temperature and pressure phases (as far as not mentioned in the "0"-sections).

- Electronic properties:

band structure / energies at symmetry points of the band structure / energy gaps (direct energy gap, indirect energy gap) / exciton energies / intra conduction band energies / intra valence band energies / critical point energies / spin-orbit splitting energies / camel's back structure of the conduction band edge / structure of the top of the valence band / effective masses (electrons, holes) / g-factor of electrons / valence band parameters.

- Lattice properties:

lattice parameters / linear thermal expansion coefficient / density / melting point / Debye temperature / heat capacity / phonon dispersion relations / phonon frequencies (wavenumbers) / sound velocities / second and third order elastic moduli / bulk modulus / Poisson ratio / internal strain parameter.

- Transport properties:

electrical conductivity or resistivity (intrinsic conductivity) / (intrinsic) carrier concentration / carrier mobilities (electron mobility, hole mobility) /drift velocities and diffusion constants / thermal conductivity (resistivity) / Seebeck coefficient (thermoelectric power) / piezo- and elastoresistance coefficients.

- Optical properties:

optical constants / absorption coefficient / reflectance / extinction coefficient / refractive index / dielectric function / dielectric constants / piezo- and elastooptic coefficients.

- Impurities and defects:

binding energies of impurities / energy levels of impurities, defects and complexes or of deep centers.

The following restrictions should be taken in mind when using these tables:

- Only figures on crystal structure, band structures and Brillouin zones are shown in the printed part of this book. About 1000 further figures on the temperature dependence of semiconductor parameters and on optical spectra as well as all references are left to the enclosed CD-ROM. Such figures are printed in italics with the addition (CD), e.g. Fig. 2.3.4 (CD). Figures in the "0"-sections of the printed volume are referred to with the page number.
- Physical data can be judged confidentally only by added information about measuring and evaluation methods, about the reference the value has been taken from etc. All this valuable information is lacking in the printed chapters because of the restriction of the number of pages. Adding such information in the present book had surpassed the frame of this volume.
- The data presented here have often to be chosen from several values, given in the Landolt-Börnstein volumes, if no unique choice had been possible for the author of the respective chapter. In such cases the "most reliable one" according to the judgement of the author of this book or the "newest one" has been listed.

CD-ROM

This book contains a CD-ROM with the full content of the printed pages and additionally more than 100 pages of references and about 1000 figures. Thus the reader can gain information in three stages:

- firstly be inspecting the tables of this book.
- secondly by getting additional information from the CD-ROM,
- finally by referring to the 17 Landolt-Börnstein volumes on semiconductors or their Internet version or of course to the original papers referred to in the Reference Lists on the CD-ROM.

2 Physical quantities tabulated in this volume

Data on the following physical quantities occur in the tables and figures of Parts B ... F:

Electronic structure

Brillouin zones:

Brillouin zones for individual semiconductors are shown in the "0"-sections at the beginning of a chapter dealing with a group of semiconducting materials. Symmetry lines and points within a Brillouin zone are designed by letters $(\Gamma, X, L, \Sigma ...)$. Subscripts to these letters designate the irreducible representation of the respective energy state (1, 1', 2, 12, 25'...).

band structure:

The function E(k) gives the energies of a band state at a wave vector k in the Brillouin zone. Instead of the value of k often the respective symmetry designation in the Brillouin zone is given $(E(\Gamma_{25'})$...). Figures on band structure show the values of E(k) along axes and at points of high symmetry.

band structure and exciton parameters:

band energies (unit eV):

 $E_{\rm c}, E_{\rm v}$ energies of the edges of conduction and valence bands, respectively.

 $E_{\rm g}$ energy gap between conduction and valence band. Further subscripts refer to: dir: direct gap, ind: indirect gap, opt: optical gap (threshold energy for optical transitions), th: thermal gap (energy gap extrapolated to 0 K from transport measurements), \parallel , \perp electric field parallel or perpendicular to a crystal axis; L(T) superscripts for longitudinal (transverse) exciton energies.

Δ mostly spin-orbit splittings of energy levels (subscripts 0, so, 1, 2 and dashes (') refer to the location of the level as explained in the tables), also other splittings of energy levels (cf: crystal-field splitting, camel's back parameters (see below)).

 E_0 ... the letter E with other subscripts refers to intra- and interband transitions (critical points) as explained in the tables $(E_0, E_1, E_2, ...)$.

exciton energies (unit eV):

 $E_{\rm b}$ binding energy of an exciton.

 $E_{\rm gx}$ energy of the excitonic gap (defined as energy gap minus exciton binding energy).

E(1S) energy of the exciton 1S state; excited states are designated by E(2S), E(2P)

 E_{L-T} longitudinal-transverse exciton splitting energy.

 $E_{\rm ex}$ exciton exchange interaction energy

effective masses (in units of the electron mass m_0):

 $m_{\rm p}$, $m_{\rm p}$ effective mass of electrons (holes) defined by

 $E(k) = E(\Gamma) + \hbar^2 k^2 / 2m_n$ at the bottom of the conduction band or

 $E(k) = E(\Gamma) - \hbar^2 k^2 / 2m_p$ at the top of the valence band

where Γ designates the center of the Brillouin zone. For very small effective electron masses the parabolic approximation $E \propto k^2$ becomes invalid (occurrence of *k*-linear terms).

 $m_{\rm c}$... other subscripts refer to: c: conductivity effective mass, cr: cyclotron resonance effective mass, ds: density of states mass, p,h: heavy holes, p,l: light holes, so: effective mass in the spin-orbit split band, (X ...): effective mass at symmetry point X ...

g-factor:

gc g-factor of electrons.

4

special band structure parameters (mostly for tetrahedrally bonded semiconductors, see also the "0"-sections of the respective chapters):

A, B, C anisotropy parameters of warped energy surfaces at the top of the valence band (symmetry Γ_8) of semiconductors with diamond or zincblende structure, defined by the equation

$$E(\boldsymbol{k}) = E(\Gamma) + (\hbar^2 k^2 / 2m_0) (A \pm (B^2 + sC^2)^{1/2}), \ s = (k_x^2 k_y^2 + k_y^2 k_z^2 + k_z^2 k_x^2) k^4$$

The \pm -sign refers to the two bands into which $E(\Gamma_8)$ splits for $k \neq 0$. By spin-orbit splitting a second valence band of Γ_6 , Γ_7 -symmetry is situated below the degenerate Γ_8 -valence band.

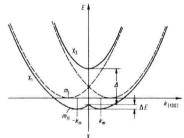
 m_{\parallel}, m_{\perp} longitudinal and transverse effective masses defined by the equation

 $E(\mathbf{k}) = E(\mathbf{k}_0) + \hbar^2 \kappa_{\rm x}^2 / 2m_{\parallel} + \hbar^2 (\kappa_{\rm y}^2 + \kappa_{\rm z}^2) / 2m_{\perp}$ where $\kappa = \mathbf{k} - \mathbf{k}_0$ and $\kappa_{\rm x} \parallel k_0$, $\kappa_{\rm y}$, $\kappa_{\rm z} \perp k_0$, if the band minima are situated at $\mathbf{k} \neq 0$ along a symmetry axis (Δ or Λ) (*ellipsoidal energy surfaces*).

 k_{\parallel}, k_{\perp} ... parameters of the *camel's back structure* at the bottom of the conduction band in several zincblendetype semiconductors defined by the equation

$$E(\mathbf{k}) = \hbar^2 \mathbf{k}_{\parallel}^2 / 2m_{\rm l} + \hbar^2 k_{\perp}^2 / 2m_{\rm t} - ((\Delta/2)^2 + \Delta_0 \hbar^2 k^2 / 2m_{\rm l})^{1/2}$$

with k_{\parallel} and k_{\perp} : components of the wave vector parallel and perpendicular to the [100]-direction, respectively, $m_{\rm t}$: effective mass perpendicular to the [100]-direction; Δ_0 : parameter describing the non-parabolicity; all other parameters are explained in the figure (right).



 k_{\parallel}, k_{\perp} also components of the **k**-vector near the top of the valence band in semiconductors with wurtzite lattice, defined by

$$E_1(\mathbf{k}) = E(\Gamma_6) + a\mathbf{k}_{\parallel}^2 + b\mathbf{k}_{\perp}^2,$$

$$E_{2,3}(\mathbf{k}) = E(\Gamma_6) \pm \Delta/2 + c\mathbf{k}_{\parallel}^2 + d\mathbf{k}_{\perp}^2 \pm ((\Delta/2 + c'\mathbf{k}_{\parallel}^2 + d'\mathbf{k}_{\perp}^2)^2 + (c''\mathbf{k}_{\parallel}^2 + d''\mathbf{k}_{\perp}^2)^2)^{1/2}.$$

 $E_1(0)$ and $E_{2,3}(0)$ are separated by the crystal-field splitting energy Δ (Δ_{cf}).

Lattice properties

static lattice parameters:

a, b, c lattice parameters (unit Å or nm)

 α, β, γ angles

α linear thermal expansion coefficient (unit K⁻¹)

d density (unit g cm⁻³)

T_m melting temperature (unit K)

 T_{dec} decomposition temperature (unit K)

 Θ_{D} Debye temperature (unit K)

 C_p , C_v heat capacities (unit J mol⁻¹K⁻¹)

dynamic lattice parameters:

v(k) phonon dispersion relation (dependence of phonon frequency on wave vector), instead of k often the reduced wave vector $\zeta = k/k_{\text{max}}$ is used

 v, \overline{v} phonon frequency (unit s⁻¹), wavenumber (unit cm⁻¹)

hv photon energy (unit eV)

Subscripts to the frequencies (wavenumbers) refer to transverse and longitudinal optical and acoustic branches (TO, LO, TA, LA) and to the symmetry points in the Brillouin zone as for the band structure energies. Further subscripts refer to Raman active (R) and infrared active (ir) modes.

 v_i sound velocities (unit cm s⁻¹)

 $c_{\rm lm}$, $c_{\rm lmn}$ second order and third order elastic moduli (unit dyn cm⁻²)

B bulk modulus (dyn cm⁻²) (Subscript S: adiabatic bulk modulus)

G shear modulus (unit GPa)

E Young's modulus (unit GPa)

v Poisson's ratio (dimensionless)

ζ internal strain parameter (dimensionless)

Transport properties

R resistance (unit Ω)

 $R_{\rm H}$ Hall coefficient (unit cm³ C⁻¹)

 $\sigma_{\rm s}$ ($\sigma_{\rm i}$) (intrinsic) electrical conductivity (unit Ω^{-1} cm⁻¹)

 ρ electrical resistivity (unit Ω cm)

 κ thermal conductivity (subscript L: lattice contribution) (unit W cm⁻¹ K⁻¹)

E_A activation energy (mostly for temperature dependence of conductivity) (unit eV)

 n, p, n_i electron and hole concentration, intrinsic carrier concentration (unit cm⁻³)

 μ_n , μ_p electron and hole mobilities, respectively (unit cm² V⁻¹s⁻¹). Further subscripts refer to: dr: drift mobility, c: conductivity mobility, H: Hall mobility, \parallel , \perp : parallel (perpendicular) to a principal axis

drift velocities of electrons and holes (unit cm s⁻¹)

S Seebeck coefficient (thermoelectric power) (unit V/K)

 π_{ik} piezoresistance coefficients (unit cm² dyn⁻¹)

 m_{ik} elastoresistance coefficients (dimensionless)

 e_{ik} , d_{ik} , g_{ik} , h_{ik} piezoelectric coefficients

Optical properties

 v_n , v_p

K absorption coefficient (unit cm⁻¹)

R reflectance (dimensionless)

In	troc	110	tion	

n	(real) refractive index (dimensionless)
k	extinction coefficient (dimensionless)
ε , ε_{ik}	dielectric constant (component of the dielectric tensor); subscripts and brackets refer to: 1: real part of the complex dielectric constant, 2: imaginary part of the complex dielectric constant, 0: low frequency limit, ∞ : high frequency limit, ∞ : parallel or perpendicular to a crystal axis
π_{ik}	piezooptic coefficients (unit cm ² dyn ⁻¹)
p_{ik}	elastooptic coefficients (dimensionless)
r_{ik}	linear electrooptic constant (unit m/V)
R_{ik}	quadratic electrooptic coefficient (unit m ² /V ²)
d(SHG)	second order nonlinear dielectric susceptibility (unit m/V) (SHG = second harmonic generation)
$\chi_{ijkl}^{(3)}$	third order susceptibility (unit esu)

Impurities and defects

6

- $E_{\rm b}$ binding energy of donors $(E_{\rm c} E_{\rm d})$ or acceptors $(E_{\rm a} E_{\rm v})$
- E for deep levels the type (d, a) is given; positive values refer to the valence band edge, negative values to the conduction band edge

B Tetrahedrally bonded elements and compounds

1 Elements of the IVth group and IV-IV compounds

1.0 Crystal structure and electronic structure

1.0.1 Crystal structure

The semiconductors C (Diamond), Si, Ge, Sn (grey tin) crystallize in the diamond lattice.

In this lattice each atom is surrounded by four nearest neighbors which lie with equal distances at the corner of a tetrahedron (Fig. 1.0.1). The lattice can be seen as two interpenetrating face-centered cubic lattices (Fig. 1.0.2).

The **space group** of the diamond lattice is O_h^7 – Fd3m.

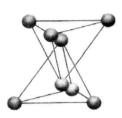


Fig. 1.0.1. Orientation of tetrahedra in the diamond structure.

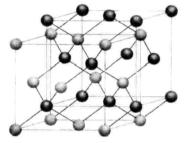


Fig. 1.0.2. The diamond lattice. The elementary cubes of the two face-centered cubic lattices are shown.

Carbon also occurs in a hexagonal modification (graphite, Fig. 1.0.3); tin crystallizes at room temperature normally in a tetragonal modification (white tin, β -Sn, Fig. 1.0.4), whereas the diamond-like grey tin (α -Sn) is stable only below 13.20°C.

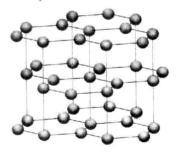




Fig. 1.0.4. Unit cell of the white tin lattice

Fig. 1.0.3. The graphite lattice

Semiconducting phases also occur in *silicon carbide*. In this binary compound the energy differences between cubic, hexagonal and rhombohedric structures are so small, that a large number of polymorphic modifications occur. More than hundred different *polytypes* exist. In all polytypes every atom is surrounded by four atoms of the other species.

The polytypes of SiC can be described in terms of a hexagonal system, the stacking order along the c-axis differing from polytype to polytype; the cubic form fits into this system by taking the [111] direction as "c-axis". Fig. 1.0.5 shows the elementary cells of the 3C (cubic, zincblende, β -SiC), 2H (hexagonal, wurtzite, α -SiC), 4H and 6H polytypes. Other hexagonal (H) and rhombohedral (R) polytypes occur.

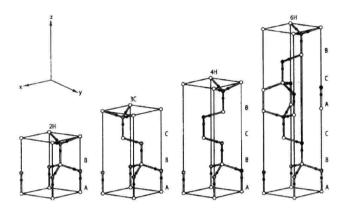


Fig. 1.0.5. Elementary cells of 3C, 2H, 4H, 6H structures. The 3C structure is also drawn in the hexagonal cell. Stacking sequences are indicated.

1.0.2 Electronic structure

General remarks on the band structure of elements with diamond structure:

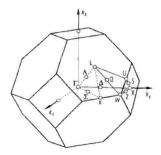
The **Brillouin zone** of the diamond structure is the Brillouin zone of the face-centered lattice, Fig. 1.0.6. Symmetry lines and points within the Brillouin zone are designed by letters $(\Gamma, X, L, \Delta ...)$.

The qualitative **band structure** is shown in Fig. 1.0.7 along the Δ and Λ axes in the Brillouin zone. Subscripts to the letters defining the location of a given energy state in the Brillouin zone designate the irreducible representation of the respective state (1, 1', 2, 12, 25'...).

Conduction band edge: Fig 1.0.7 shows only the topological connection of the subbands of the conduction band. Two possibilities are to be considered in connection with the band structure of group IV elements:

Lowest band state at Γ : In this case the energy E(k) can be approximated near the band edge by a scalar quadratic k-dependence: $E(k) = E(\Gamma) + \hbar^2 k^2 / 2m_{\rm p}$.

Fig. 1.0.6. Brillouin zone of the diamond lattice.



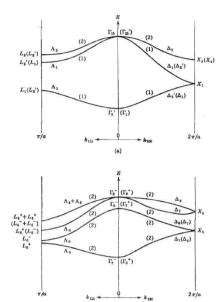


Fig. 1.0.7. Qualitative picture of the band structure of a semiconductor with diamond structure (a) without inclusion of spin, (b) with spin taken into account. This qualitative shape applies both to the valence and the conduction bands. The symmetry symbols are the same for the two cases except where valence band symbols differing from those for the conduction band are shown in brackets. Where a point or line is labeled with two symbols without brackets, it means that symmetry arguments alone cannot distinguish between the two possibilities. Degeneracies of the band are given in brackets.

Lowest band state along a symmetry axis (Δ or Λ): In the case that the lowest band state lies at a point k_0 at a symmetry axis the band edge can be approximated by $E(\mathbf{k}) = E(\mathbf{k}_0) + \hbar^2 \kappa_{\rm x}^2 / 2m_{\parallel} + \hbar^2 (\kappa_{\rm y}^2 + \kappa_{\rm z}^2) / 2m_{\perp}$ where $\kappa = \mathbf{k} - \mathbf{k}_0$ and $\kappa_{\rm x} \parallel k_0$, $\kappa_{\rm y}$, $\kappa_{\rm z} \perp k_0$ (ellipsoidal energy surfaces).

Valence band edge: In all group IV elements the top of the valence band is situated at the center Γ of the Brillouin zone (Γ_{25}). According to Fig. 1.0.7 this state is triply degenerated if the spin-orbit coupling can be neglected. Taking spin into account the (now sixfold degenerated) state splits into the fourfold degenerated Γ_8^+ state and a lower lying twofold degenerated Γ_7^+ state, separated by the spin-orbit splitting energy Δ_{so} . At $k \neq 0$ two subbands (degenerated at Γ) build the band edge. Their energy can be approximated by

$$E(\mathbf{k}) = E(\Gamma) + (\hbar^2 k^2 / 2m_0)(A \pm (B^2 + sC^2)^{1/2}), s = (k_x^2 k_y^2 + k_y^2 k_z^2 + k_z^2 k_x^2)k^4$$

The \pm -sign refers to the two bands into which $E(\Gamma_8^+)$ splits at $k \neq 0$ (warped surfaces).

Special band structures:

According to Figs. 1.0.8 ... 1.0.13 the semiconducting group IV elements and IV-IV compounds show the following band structures:

Diamond and silicon are indirect semiconductors, the lowest minima of the conduction band being located on the Δ -axis.

Germanium is an indirect semiconductor too, but in contrast to C and Si the lowest minima of the conduction band are located at the endpoints L of the Λ -axis.

Grey tin is a zero gap semiconductor, where the top of the valence band and the bottom of the conduction band are degenerated.

Silicon carbide is an indirect semiconductor, the lowest minima of the conduction band being located at the end points X of the cubic axes (X in the cubic polytype, K in the hexagonal 2H polytype).

The valence bands of all five semiconductors are identical as shown in Fig. 1.0.7 (warped surfaces).